

LIST OF REFERENCES CITED BY APPLICANT
(Use several sheets if necessary)

| | |
|-----------------------------|---------------|
| Application Number | 10/603,115 |
| Filing Date | June 24, 2003 |
| First Named Inventor | Ni DING |
| Art Unit | 3774 |
| Examiner Name | Suba GANESAN |
| Attorney Docket No. | 10177-191-999 |

U.S. PATENT DOCUMENTS

| *Examiner Initials | Cite No. | Document Number Number – Kind Code | Publication Date MM/DD/YYYY | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear |
|--------------------|----------|---------------------------------------|--------------------------------|--|---|
| | A01 | US – 5,616,338 | 04/01/1997 | Fox, Jr. <i>et al.</i> | |
| | A02 | US – 5,165,952 | 11/24/1992 | Solomon <i>et al.</i> | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |

FOREIGN PATENT DOCUMENTS

| *Examiner Initials | Cite No. | Foreign Patent Document Country Code, Number, Kind Code (if known) | Publication Date MM/DD/YYYY | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear | T |
|--------------------|----------|--|--------------------------------|--|---|---|
| | B01 | EP 0 328 421 | 08/16/1989 | The Trustees of Columbia University in the City of New York | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |

NON PATENT LITERATURE DOCUMENTS

| *Examiner Initials | Cite No. | Include name of the author (in CAPITAL LETTERS), (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T |
|--------------------|----------|--|---|
| | | | |
| | | | |
| | | | |

NYI-4193890v1

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.